

# 110-13-632-41-001000

## 110-13-632-41-001000 Information

Wayne ener.com	 110-13-632-41-001000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 32POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

# **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



# 110-13-632-41-001000 Specifications

Manufacturer Part Number110-13-632-41-001000ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsCategorySockets for ICs, TransistorsPackage-Series110TypeDIP, 0.6" (15.24mm) Row SpacingNumber of Positions or Pins (Grid)32 (2 x 16)Pitch - MatingOn100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)
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Contact Material - Mating Beryllium Copper
Mounting Type Through Hole
Features Open Frame
Termination Solder
Pitch - Post 0.100" (2.54mm)
Contact Finish - Post Gold
Contact Finish Thickness - Post 10µin (0.25µm)
Contact Material - Post Brass Alloy
Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Polyester
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$
Report err

## 110-13-632-41-001000 Guarantees



Quality Guarantees

We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

## 110-13-632-41-001000 Payment Methods





If you have any question about 110-13-632-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com